

# UNISONIC TECHNOLOGIES CO., LTD

UF40N07 Preliminary Power MOSFET

# 40A, 70V N-CHANNEL POWER MOSFET

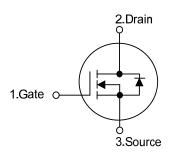
#### **■** DESCRIPTION

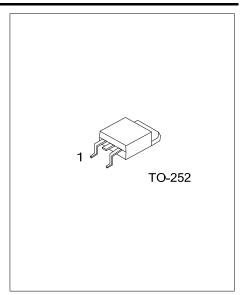
The UTC **UF40N07** is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.



- \*  $R_{DS(ON)}$  < 25 m $\Omega$  @  $V_{GS}$ =10V,  $I_{D}$ =20A
- \* High switching speed
- \* 100% avalanche tested

#### ■ SYMBOL

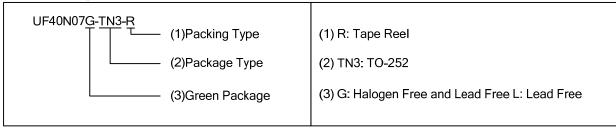




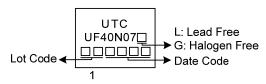
#### **■ ORDERING INFORMATION**

Ordering Number		Daakawa	Pin Assignment			Daakina	
Lead Free	Halogen Free	Package	1	2	3	Packing	
UF40N07L-TN3-R	UF40N07G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



#### ■ MARKING



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#### ■ ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> =25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		$V_{DSS}$	70	V	
Gate-Source Voltage		$V_{GSS}$	±25	V	
Continuous Drain Current	Continuous	$I_{D}$	40	Α	
	Pulsed	$I_{DM}$	160	Α	
Avalanche Energy		E <sub>AS</sub>	200	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	18	V/ns	
Power Dissipation		$P_{D}$	1	mW	
Junction Temperature		$T_J$	+150	°C	
Storage Temperature Range		$T_{STG}$	-55 ~ <b>+</b> 150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L=0.8mH,  $I_{AS}$ =22.3A,  $V_{DD}$ =50V,  $R_{G}$ =25  $\Omega$ , Starting  $T_{J}$  = 25°C
- 4.  $I_{SD} \le 30A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$

#### **■ THERMAL DATA**

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	$\theta_{JA}$	110	°C/W	
Junction to Case	θις	1.95	°C/W	

## ■ ELECTRICAL CHARACTERISTICS (T<sub>A</sub> =25°C, unless otherwise specified)

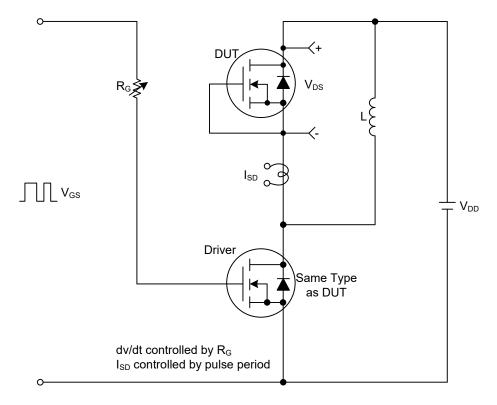
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	I <sub>D</sub> =250µA, V <sub>GS</sub> =0V	70			V	
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =70V, V <sub>GS</sub> =0V			1	μA	
Gate-Source Leakage Current	Forward	Igss	V <sub>GS</sub> =+20V, V <sub>DS</sub> =0V			10	μA	
	Reverse		V <sub>GS</sub> =-20V, V <sub>DS</sub> =0V			-10	μA	
ON CHARACTERISTICS								
Gate Threshold Voltage		V <sub>GS(TH)</sub>	I <sub>D</sub> =250μA, V <sub>DS</sub> =V <sub>GS</sub>	2.0		4.0	V	
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =20A			25	mΩ	
DYNAMIC PARAMETERS								
nput Capacitance		C <sub>ISS</sub>			1613		pF	
Output Capacitance		Coss	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1MHz		306		pF	
Reverse Transfer Capacitance		C <sub>RSS</sub>			36		pF	
SWITCHING PARAMETERS								
Total Gate Charge (Note 1)		$Q_G$	V <sub>GS</sub> =50V, V <sub>DS</sub> =50V, I <sub>D</sub> =1.3A		116		nC	
Gate to Source Charge		$Q_GS$	I <sub>G</sub> =100μA (Note 1, 2)		9		nC	
Gate to Drain Charge		$Q_GD$	IG-100μA (Note 1, 2)		14		nC	
Turn-ON Delay Time (Note 1)		t <sub>D(ON)</sub>			70		ns	
Rise Time Turn-OFF Delay Time Fall-Time		$t_{R}$	$V_{GS}$ =30V, $V_{DD}$ =30V, $R_{G}$ =25 $\Omega$ ,		72		ns	
		t <sub>D(OFF)</sub>	<sub>D</sub> =0.5A (Note 1, 2)		360		ns	
		t <sub>F</sub>			100		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuous Current		Is				40	Α	
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>				160	Α	
Drain-Source Diode Forward Voltage (Note 1)		$V_{SD}$	I <sub>S</sub> =40A, V <sub>GS</sub> =0V			1.4	V	
Body Diode Reverse Recovery Time (Note 1)		t <sub>rr</sub>	I <sub>S</sub> =40A, V <sub>GS</sub> =0V		66		ns	
Body Diode Reverse Recovery Charge		$Q_{rr}$	dI <sub>F</sub> /dt = 100A/μs		0.16		μC	

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

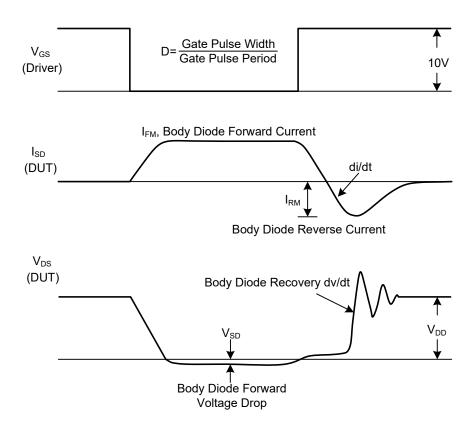
<sup>2.</sup> Essentially independent of operating temperature.



### **■ TEST CIRCUITS AND WAVEFORMS**

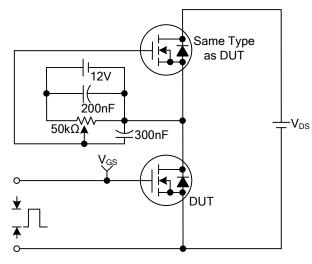


Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

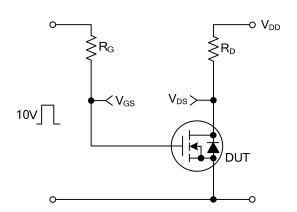
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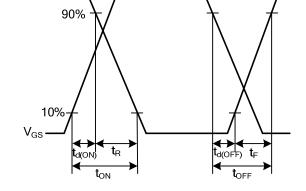


 $Q_{GS}$   $Q_{GS}$   $Q_{GD}$   $Q_{GS}$   $Q_{GD}$   $Q_{GD}$ 

Gate Charge Test Circuit

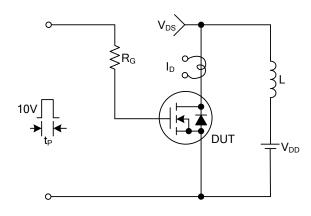
Gate Charge Waveforms

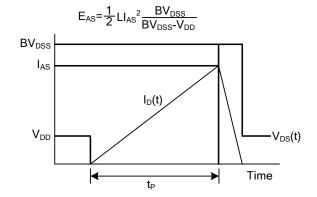




Resistive Switching Test Circuit

Resistive Switching Waveforms





Unclamped Inductive Switching Test Circuit

**Unclamped Inductive Switching Waveforms** 

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